

FSAV433

High Bandwidth (550MHz) 3 Channel 3:1 Video Switch

General Description

The FSAV433 is an ultra low power high bandwidth video switch specially designed for the switching of three analog video signals, including computer RGB and high definition YPbPr signals. The wide bandwidth (550MHz) of this switch allows signal passage with minimum edge and phase distortion while -70dB non-adjacent channel crosstalk generates negligible image noise between active channels. Optimized differential gain and differential phases maintain the image integrity of video applications while low On Resistance offers low signal insertion loss.

Features

- Ground between channels to optimize isolation and hostile crosstalk
- -70dB non-adjacent channel crosstalk at 30MHz
- 6.5Ω typical On Resistance (R_{ON})
- -3dB bandwidth: 550MHz
- Low power consumption (1uA max)

Applications

- RGB Video Switch in LCD, plasma and projection displays
- DVD-RW, notebook

Ordering Code:

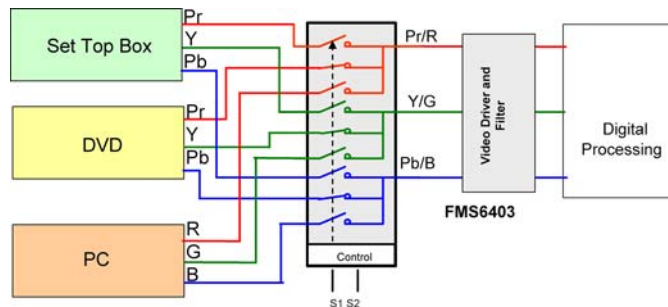
Order Number	Package Number	Package Description
FSAV433BQX (Note 1)	MLP020B	Pb-Free 20-Terminal Depopulated Quad Very-Thin Flat Pack No Leads (DQFN), JEDEC MO-241, 2.5 x 4.5mm
FSAV433MTC	MTC20	20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
FSAV433MTCX_NL (Note 2)	MTC20	Pb-Free 20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering code.
Pb-Free package per JEDEC J-STD-020B.

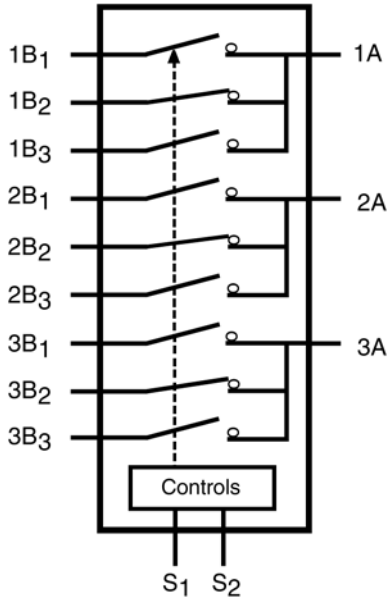
Note 1: DQFN package available in Tape and Reel only.

Note 2: "_NL" indicates Pb-Free package (per JEDEC J-STD-020B). Device available in Tape and Reel only.

Application Diagram



Analog Symbol



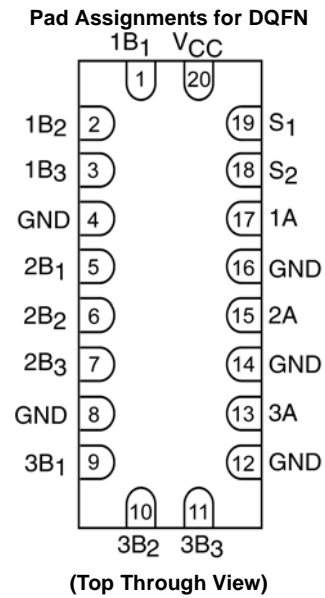
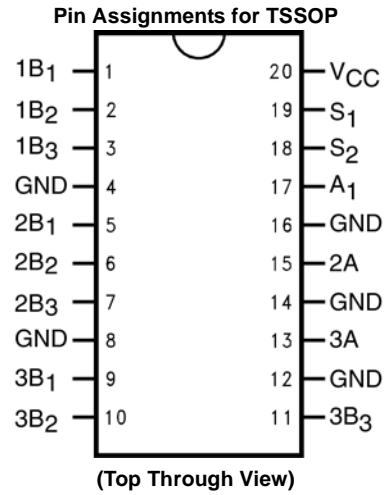
Pin Descriptions

Pin Name	Description
\overline{OE}	Bus Switch Enable
S ₁ , S ₂	Select Input
A	Bus A
B ₁ -B ₃	Bus B

Truth Table

S ₁	S ₂	Function
L	L	Disconnect
L	H	A = B ₁
H	L	A = B ₂
H	H	A = B ₃

Connection Diagrams



Absolute Maximum Ratings(Note 3)

Supply Voltage (V_{CC})	-0.5V to +4.6V
DC Switch Voltage (V_S)	-0.5V to $V_{CC} + 0.05V$
DC Input Voltage (V_{IN}) (Note 4)	-0.5V to +4.6V
DC Input Diode Current (I_{IK}) $V_{IN} < 0V$	-50 mA
DC Output (I_{OUT}) Sink Current	100 mA
DC V_{CC}/GND Current (I_{CC}/I_{GND})	± 100 mA
Storage Temperature Range (T_{STG})	-65°C to +150 °C
ESD	
Human Body Model	7kV

Recommended Operating Conditions

(Note 5)

Power Supply Operating (V_{CC})	2.3V to 3.6V
Input Voltage (V_{IN})	0V to V_{CC}
Free Air Operating Temperature (T_A)	-40 °C to +85 °C

Note 3: The Absolute Maximum Ratings are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum rating. The Recommended Operating Conditions tables will define the conditions for actual device operation.

Note 4: The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed.

Note 5: Unused control inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

Symbol	Parameter	V_{CC} (V)	$T_A = -40\text{ }^{\circ}\text{C to }+85\text{ }^{\circ}\text{C}$			Units	Conditions
			Min	Typ (Note 6)	Max		
	Analog Signal Range		0		2.0	V	
V_{IK}	Clamp Diode Voltage	3.0			-1.2	V	$I_{IN} = -18\text{ mA}$
V_{IH}	HIGH Level Input Voltage	2.3	1.8			V	
		3.0 - 3.6	2.0				
V_{IL}	LOW Level Input Voltage	2.3			0.7	V	
		3.0 - 3.6			0.8		
I_I	Input Leakage Current	3.6			± 1.0	μA	$0 \leq V_{IN} \leq 3.6V$
I_{OFF}	OFF-STATE Leakage Current	3.6			± 1.0	μA	$0 \leq A, B \leq V_{CC}$, See Figure 5
R_{ON}	Switch On Resistance (Note 7)	2.3		9.0	13.0	Ω	$V_{IN} = 1.0V$
		3.0		6.5	9.0		$I_{ON} = 13\text{ mA}$, See Figure 4
		2.3		10.0	15.0	Ω	$V_{IN} = 2.0V$
		3.0		6.5	9.0		$I_{ON} = 26\text{ mA}$, See Figure 4
I_{CC}	Quiescent Supply Current	3.6			1.0	μA	$V_{IN} = V_{CC}$ or GND, $I_{OUT} = 0$
I_{CCT}	Increase in I_{CC} Per Control Input	3.6			10.0	μA	One Control Input at 3.0V Other Inputs at V_{CC} or GND

Note 6: Typical values are at $T_A = +25^{\circ}\text{C}$

Note 7: Measured by the voltage drop between A and B pins at the indicated current through the switch. On Resistance is determined by the lower of the voltages on the two (A or B) pins.

AC Electrical Characteristics

Symbol	Parameter	V _{CC} (V)	T _A = -40°C to +85°C			Units	Conditions	Figure Number
			Min	Typ (Note 8)	Max			
t _{ON}	Turn ON Time S-to-Bus A	3.0 to 3.6			5.5	ns	V _B = 2.0V	Figures 7, 8
		2.3 to 2.7			7.0			
t _{OFF}	Turn OFF Time S-to-Bus A	3.0 to 3.6			4.0	ns	V _B = 2.0V	Figures 7, 8
		2.3 to 2.7			5.0			
DG	Differential Gain	3.0 to 3.6		0.2		%	R _L = 75Ω, f = 3.58MHz	
DP	Differential Phase	3.0 to 3.6		0.1		Degree	R _L = 75Ω, f = 3.58MHz	
O _{IRR}	Non-Adjacent OFF-Isolation	3.0 to 3.6		-45.0		dB	f = 30MHz, R _L = 75Ω	Figure 10
	Adjacent OFF-Isolation	2.3 to 2.7		-45.0				
X _{TALK}	Non-Adjacent Channel Crosstalk	3.0 to 3.6		-70.0		dB	R _L = 75Ω, f = 30MHz	Figures 11, 12
	Adjacent Channel Crosstalk	2.3 to 2.7		-70.0				
BW	-3dB Bandwidth	3.0 to 3.6		550		MHz	R _L = 50Ω	Figure 9
		3.0 to 3.6		300			R _L = 75Ω	

Note 8: Typical values are at V_{CC} = 3.3V and T_A = +25°C

Capacitance

Symbol	Parameter	T _A = -40°C to +85°C		Units	Conditions	Figure Number
		Typ (Note 9)				
C _{IN}	Control Pin Input Capacitance	3.0		pF	V _{CC} = 0V	
C _{ON}	A/B ON Capacitance	15.0		pF	V _{CC} = 3.0V = 0V	Figure 14
C _{OFF}	Port B OFF Capacitance	4.0		pF	V _{CC} = 3.0V	Figure 13

Note 9: Typical values are at V_{CC} = 3.3V and T_A = +25°C

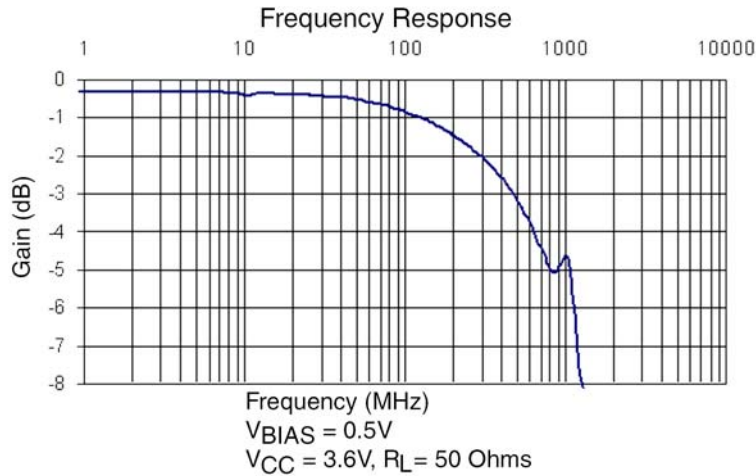


FIGURE 1. Gain vs. Frequency

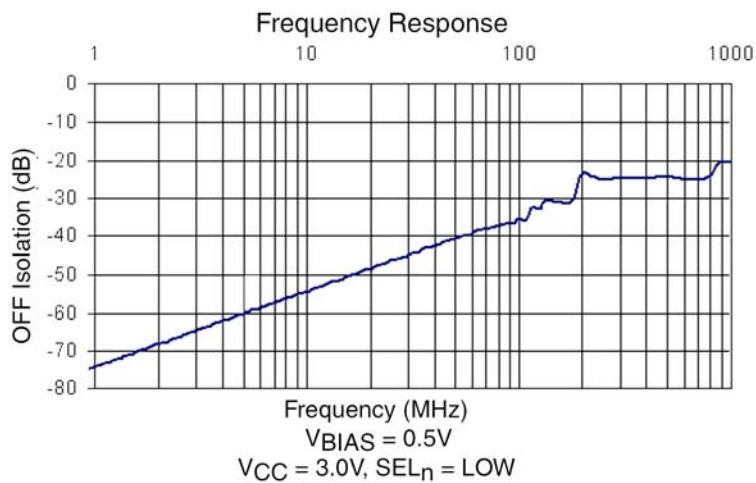


FIGURE 2. OFF Isolation

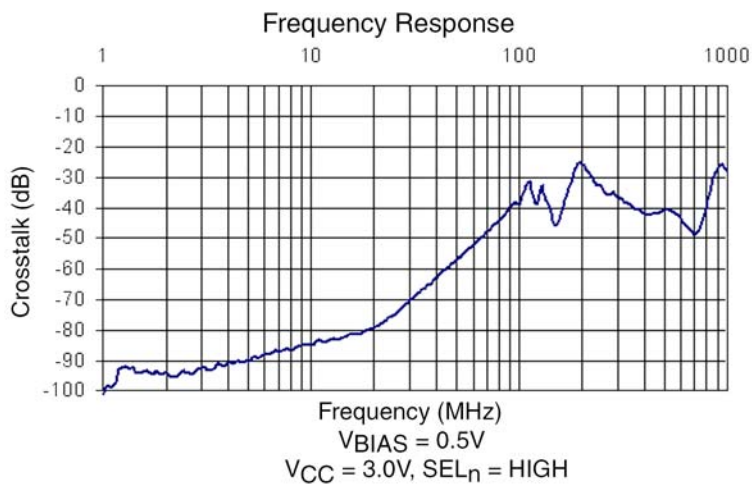


FIGURE 3. Crosstalk

Test Diagrams

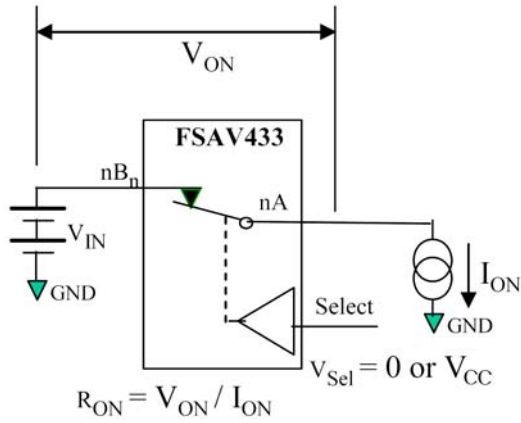


FIGURE 4. On Resistance

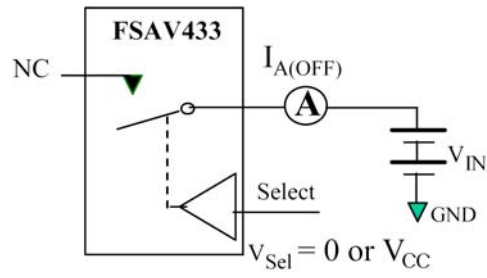


FIGURE 5. OFF Leakage

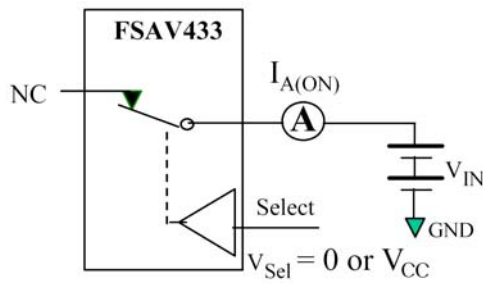
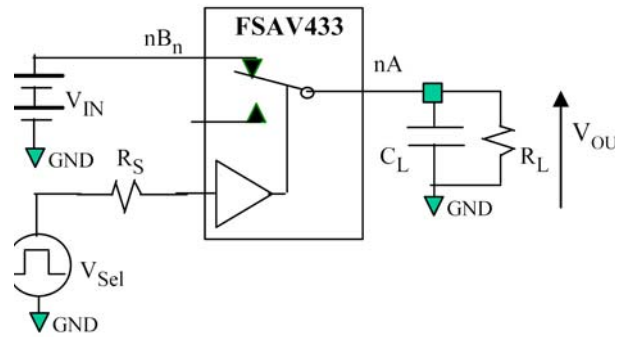


FIGURE 6. ON Leakage



R_L and C_L are functions of application environment (50, 75, or 100 Ω) C_L includes test fixture and stray capacitance

FIGURE 7. Test Circuit Load

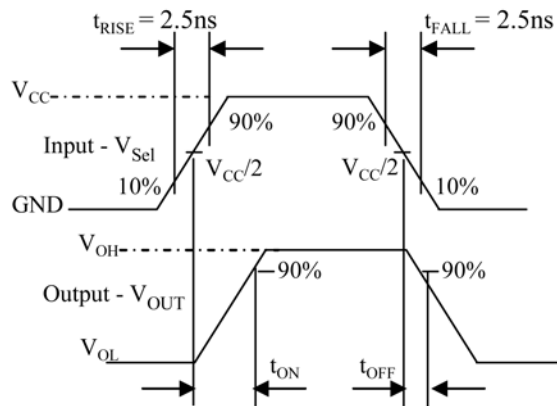
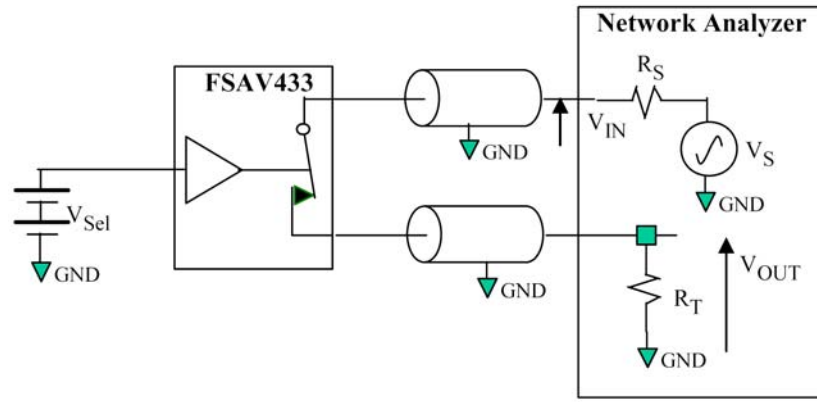
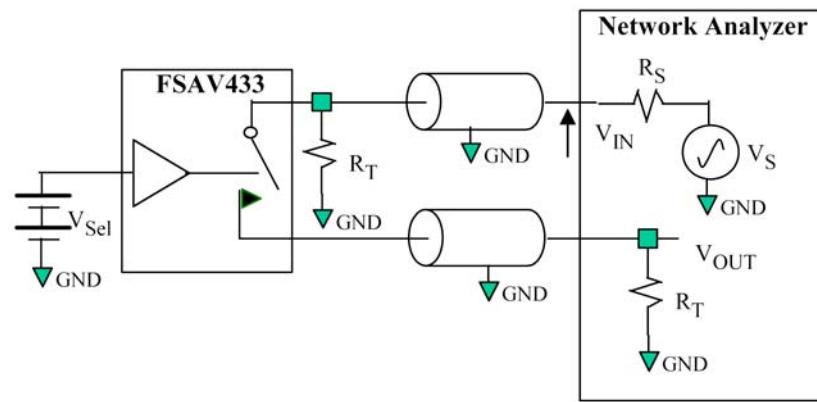


FIGURE 8. Turn ON / Turn OFF Waveforms



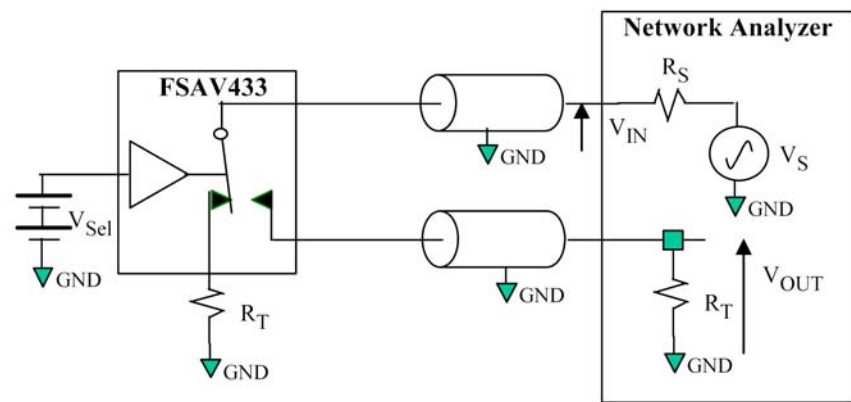
R_L and C_L are function of application environment (50, 75, or 100Ω)
 C_L includes test fixture and stray capacitance

FIGURE 9. Bandwidth



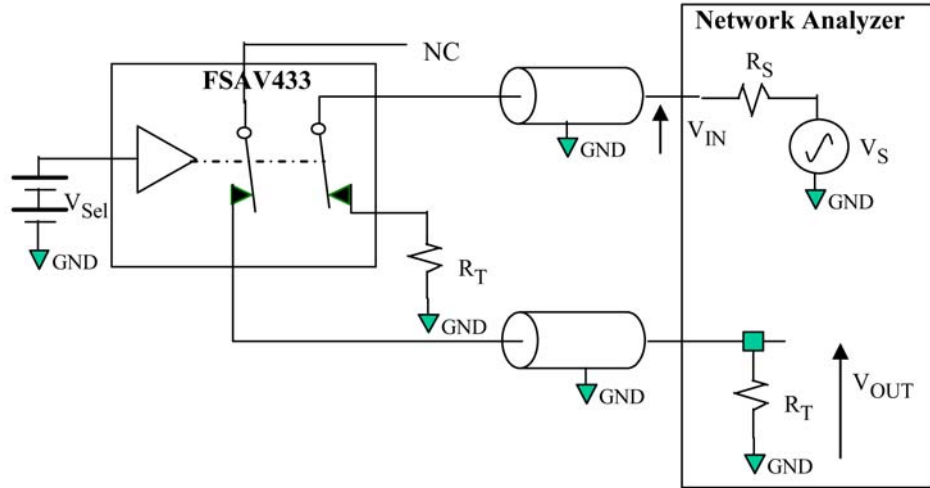
R_S and R_T are function of application environment (50, 75, or 100Ω) OFF Isolation = 20 Log (V_{OUT} / V_{IN})

FIGURE 10. Channel OFF Isolation



Crosstalk = 20 Long (V_{OUT} / V_{IN})

FIGURE 11. Adjacent Channel Crosstalk



R_S and R_T are function of application environment (50, 75, or 100 Ω)

Crosstalk = 20 Long (V_{OUT} / V_{IN})

FIGURE 12. Non-adjacent Channel-to-Channel Crosstalk

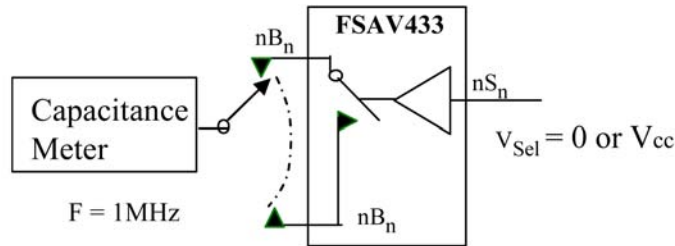


FIGURE 13. Channel OFF Capacitance

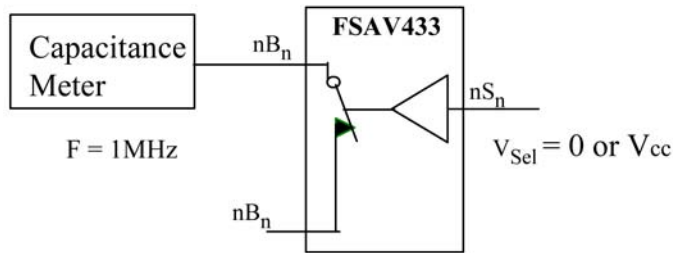


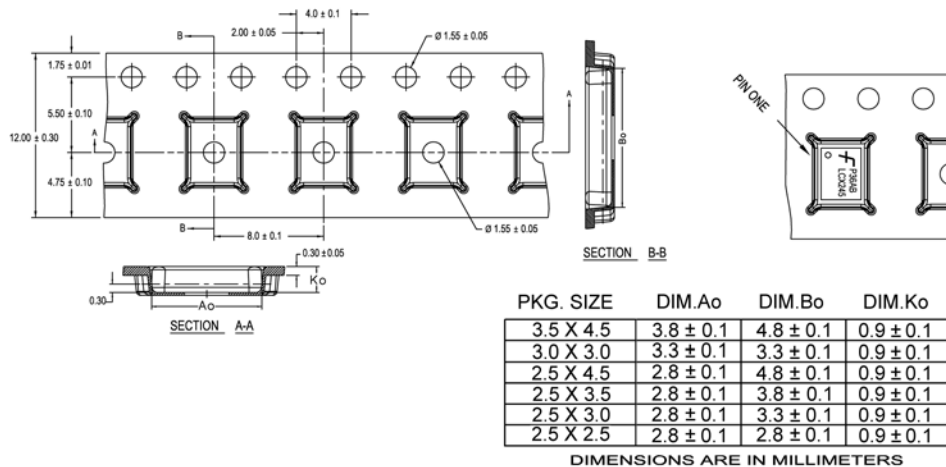
FIGURE 14. Channel ON Capacitance

Tape and Reel Specification

Tape Format for DQFN

Package Designator	Tape Section	Number Cavities	Cavity Status	Cover Tape Status
BQX	Leader (Start End)	125 (typ)	Empty	Sealed
	Carrier	2500/3000	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed

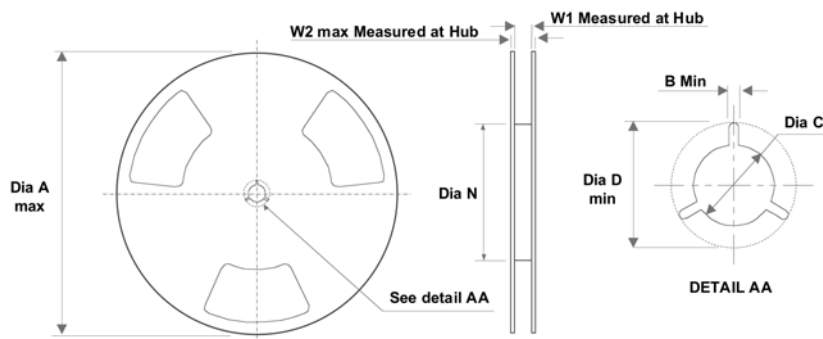
TAPE DIMENSIONS inches (millimeters)



NOTES: unless otherwise specified

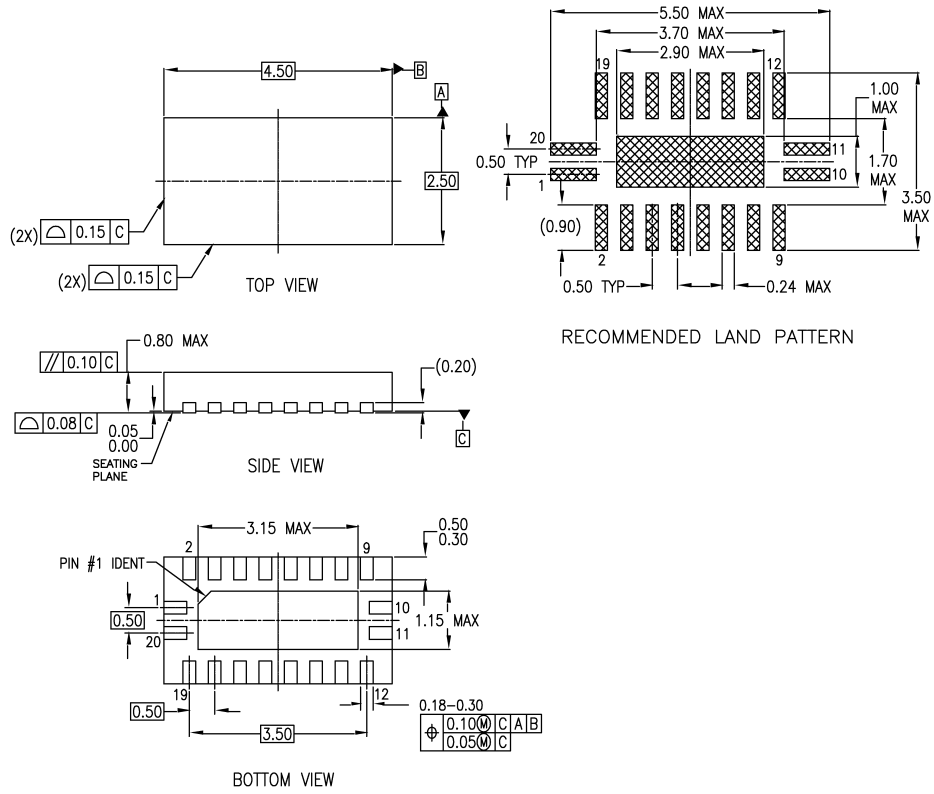
1. Cumulative pitch for feeding holes and cavities (chip pockets) not to exceed 0.008[0.20] over 10 pitch span.
2. Smallest allowable bending radius.
3. Thru hole inside cavity is centered within cavity.
4. Tolerance is ±0.002[0.05] for these dimensions on all 12mm tapes.
5. A₀ and B₀ measured on a plane 0.120[0.30] above the bottom of the pocket.
6. K₀ measured from the inside bottom of the pocket to the top surface of the carrier.
7. Pocket position relative to sprocket hole measured as true position of pocket. Not pocket hole.
8. Controlling dimension is millimeter. Dimension in inches rounded.

REEL DIMENSIONS inches (millimeters)



Tape Size	A	B	C	D	N	W1	W2
12 mm	13.0 (330)	0.059 (1.50)	0.512 (13.00)	0.795 (20.20)	7.008 (178)	0.488 (12.4)	0.724 (18.4)

Physical Dimensions inches (millimeters) unless otherwise noted



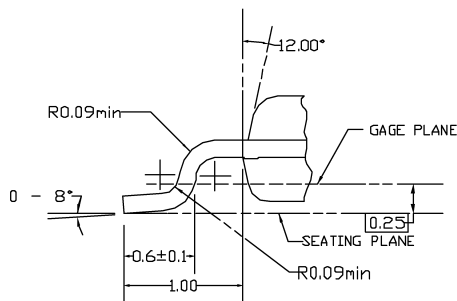
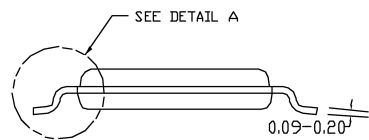
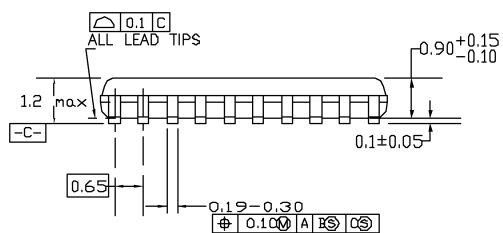
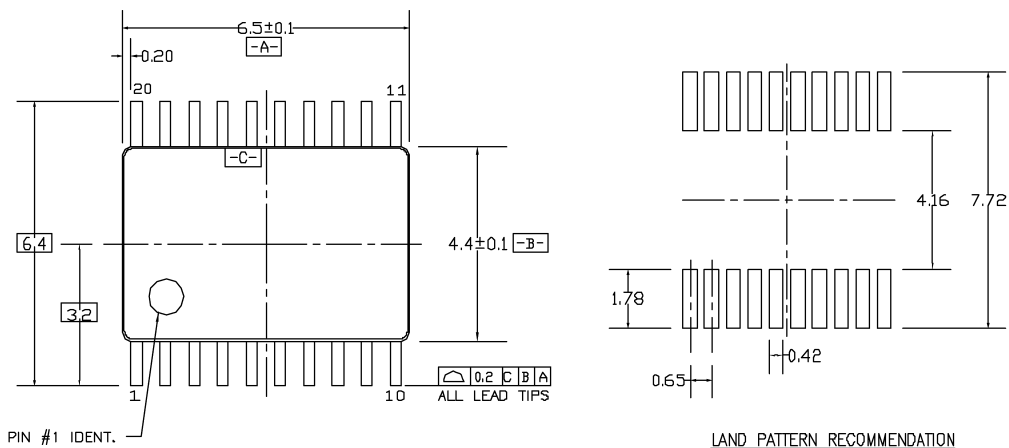
NOTES:

- A. CONFORMS TO JEDEC REGISTRATION MO-241, VARIATION AC
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994

MLP020BrevA

Pb-Free 20-Terminal Depopulated Quad Very-Thin Flat Pack No Leads (DQFN), JEDEC MO-241, 2.5 x 4.5mm Package Number MLP020B

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



DIMENSIONS ARE IN MILLIMETERS

NOTES:

- A. CONFORMS TO JEDEC REGISTRATION MO-153, VARIATION AC, REF NOTE 6, DATE 7/93.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLDS FLASH, AND TIE BAR EXTRUSIONS.
- D. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982.

MTC20REVD1

**20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
Package Number MTC20**

Technology Description

The Fairchild Switch family derives from and embodies Fairchild's proven switch technology used for several years in its 74LVX3L384 (FST3384) bus switch product.

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provided in the labeling, can be reasonably expected to result in significant injury to the user.

2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
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